



# Low Capacitance, Low Charge Injection, ±15 V/+12 V *iCMOS*® Dual SPST Switches

## ADG1221/ADG1222/ADG1223

### FEATURES

- <0.5 pC charge injection over full signal range
- Off capacitance: 2 pF
- Off leakage: 20 pA
- Supply range: 33 V
- On resistance: 120 Ω
- Fully specified at ±15 V, +12 V
- No  $V_L$  supply required
- 3 V logic-compatible inputs
- Rail-to-rail operation
- 10-lead MSOP package

### APPLICATIONS

- Automatic test equipment
- Data acquisition systems
- Battery-powered systems
- Sample-and-hold systems
- Audio signal routing
- Video signal routing
- Communication systems

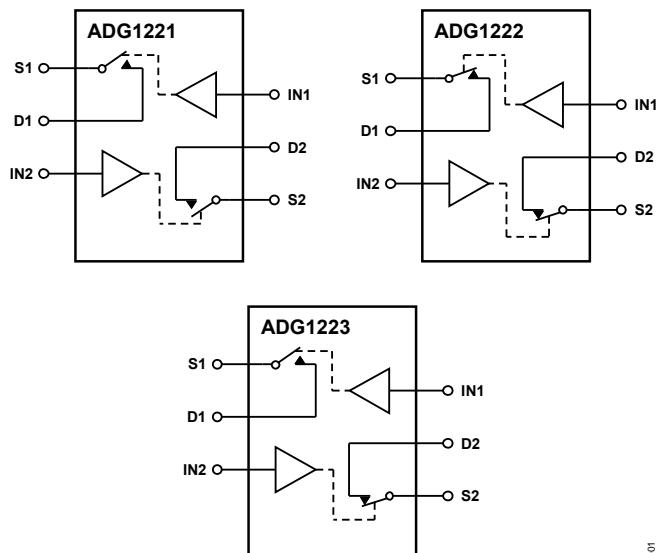
### GENERAL DESCRIPTION

The ADG1221/ADG1222/ADG1223 are monolithic, complementary metal-oxide semiconductor (CMOS) devices containing four independently selectable switches designed on an *iCMOS* (industrial CMOS) process. *iCMOS* is a modular manufacturing process combining high voltage CMOS and bipolar technologies. It enables the development of a wide range of high performance analog ICs, capable of 33 V operation, in a footprint that no previous generation of high voltage parts has been able to achieve. Unlike analog ICs using conventional CMOS processes, *iCMOS* components can tolerate high supply voltages while providing increased performance, dramatically lower power consumption, and reduced package size.

The ultralow capacitance and exceptionally low charge injection of these switches make them ideal solutions for data acquisition and sample-and-hold applications, where low glitch and fast settling are required. Figure 2 shows that there is minimum charge injection over the full signal range of the device.

The ADG1221/ADG1222/ADG1223 contain two independent single-pole/single-throw (SPST) switches. The ADG1221 and ADG1222 differ only in that the digital control logic is inverted. The ADG1221 switches are turned on with Logic 1 on the appropriate control input, and Logic 0 is required for the

### FUNCTIONAL BLOCK DIAGRAM



SWITCHES SHOWN FOR A LOGIC 0 INPUT

Figure 1.

06574-001

ADG1222. The ADG1223 has one switch with digital control logic similar to that of the ADG1221; the logic is inverted on the other switch. The ADG1223 exhibits break-before-make switching action for use in multiplexer applications. Each switch conducts equally well in both directions when on and has an input signal range that extends to the supplies. In the off condition, signal levels up to the supplies are blocked.

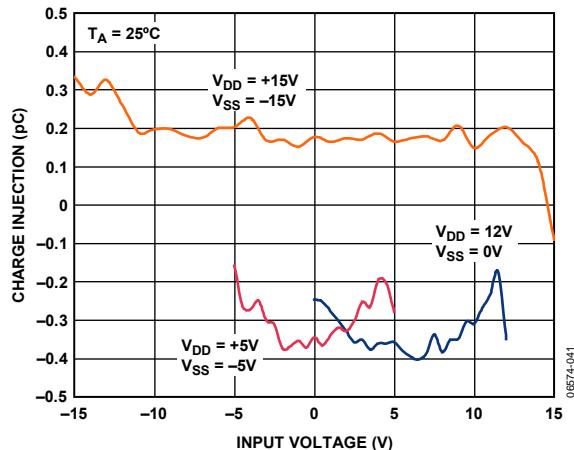


Figure 2. Charge Injection vs. Input Voltage

Rev. A

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A.  
Tel: 781.329.4700 [www.analog.com](http://www.analog.com)  
Fax: 781.461.3113 ©2007–2009 Analog Devices, Inc. All rights reserved.

# ADG1221/ADG1222/ADG1223

## TABLE OF CONTENTS

Features .....	1	Thermal Resistance .....	6
Applications.....	1	ESD Caution.....	6
Functional Block Diagram .....	1	Pin Configuration and Function Descriptions.....	7
General Description.....	1	Terminology .....	8
Revision History .....	2	Typical Performance Characteristics .....	9
Specifications.....	3	Test Circuits.....	13
Dual Supply .....	3	Outline Dimensions .....	15
Single Supply .....	4	Ordering Guide .....	15
Absolute Maximum Ratings.....	6		

## REVISION HISTORY

### 3/09—Rev. 0 to Rev. A

Changes to Power Requirements, $I_{DD}$ , Digital Inputs = 5 V Parameter, Table 1.....	4
Changes to $t_{ON}$ Parameter and Power Requirements, $I_{DD}$ , Digital Inputs = 5 V Parameter, Table 2.....	5

### 2/07—Rev. 0: Initial Version

## SPECIFICATIONS

### DUAL SUPPLY

$V_{DD} = 15 \text{ V} \pm 10\%$ ,  $V_{SS} = -15 \text{ V} \pm 10\%$ , GND = 0 V, unless otherwise noted.

Table 1.

Parameter	25°C	Temperature			Unit	Test Conditions/Comments
		-40°C to +85°C	-40°C to +125°C			
ANALOG SWITCH		$V_{DD}$ to $V_{SS}$				
Analog Signal Range					V	
On Resistance, $R_{ON}$	120	240	270		$\Omega$ typ	$V_{DD} = +13.5 \text{ V}$ , $V_{SS} = -13.5 \text{ V}$ , $V_S = \pm 10 \text{ V}$ , $I_S = -1 \text{ mA}$ (see Figure 23)
On Resistance Match Between Channels, $\Delta R_{ON}$	2.5	10	12		$\Omega$ max	$V_S = \pm 10 \text{ V}$ , $I_S = -1 \text{ mA}$
On Resistance Flatness, $R_{FLAT(ON)}$	6	20	64	76	$\Omega$ typ	$V_S = -5 \text{ V}/0 \text{ V}/+5 \text{ V}$ ; $I_S = -1 \text{ mA}$
					$\Omega$ max	
LEAKAGE CURRENTS						
Source Off Leakage, $I_S$ (Off)	$\pm 0.002$				nA typ	$V_{DD} = +16.5 \text{ V}$ , $V_{SS} = -16.5 \text{ V}$
	$\pm 0.1$	$\pm 0.6$	$\pm 1$		nA max	$V_S = \pm 10 \text{ V}$ , $V_D = \pm 10 \text{ V}$ (see Figure 24)
Drain Off Leakage, $I_D$ (Off)	$\pm 0.002$				nA typ	$V_S = \pm 10 \text{ V}$ , $V_D = \pm 10 \text{ V}$ (see Figure 24)
	$\pm 0.1$	$\pm 0.6$	$\pm 1$		nA max	
Channel On Leakage, $I_D$ , $I_S$ (On)	$\pm 0.01$				nA typ	$V_S = V_D = \pm 10 \text{ V}$ (see Figure 25)
	$\pm 0.2$	$\pm 0.6$	$\pm 1$		nA max	
DIGITAL INPUTS						
Input High Voltage, $V_{INH}$			2.0		V min	
Input Low Voltage, $V_{INL}$			0.8		V max	
Input Current, $I_{INL}$ or $I_{INH}$	0.005				$\mu\text{A}$ typ	$V_{IN} = V_{INL}$ or $V_{INH}$
Digital Input Capacitance, $C_{IN}$	2.5		$\pm 0.1$		$\mu\text{A}$ max	
					pF typ	
DYNAMIC CHARACTERISTICS <sup>1</sup>						
$t_{ON}$						$R_L = 300 \Omega$ , $C_L = 35 \text{ pF}$ , $V_S = 10 \text{ V}$ (see Figure 26)
	130	170	210	240	ns typ	
					ns max	$R_L = 300 \Omega$ , $C_L = 35 \text{ pF}$ , $V_S = 10 \text{ V}$ (see Figure 26)
$t_{OFF}$	85	105	130	140	ns typ	
					ns max	$R_L = 300 \Omega$ , $C_L = 35 \text{ pF}$ , $V_{S1} = V_{S2} = 10 \text{ V}$ (see Figure 27)
Break-Before-Make Time Delay (ADG1223 Only), $t_{BBM}$	40			10	ns typ	
					ns min	
Charge Injection, $Q_{IN}$	0.1				$\mu\text{C}$ typ	$V_S = 0 \text{ V}$ , $R_S = 0 \Omega$ , $C_L = 1 \text{ nF}$ (see Figure 28)
Off Isolation	75				dB typ	$R_L = 50 \Omega$ , $C_L = 1 \text{ pF}$ , $f = 1 \text{ MHz}$ (see Figure 29)

# ADG1221/ADG1222/ADG1223

Parameter	Temperature			Unit	Test Conditions/Comments
	25°C	-40°C to +85°C	-40°C to +125°C		
Channel-to-Channel Crosstalk Total Harmonic Distortion + Noise, THD + N -3 dB Bandwidth $C_s$ (Off)	90			dB typ	$R_L = 50 \Omega, C_L = 1 \text{ pF}, f = 1 \text{ MHz}$ (see Figure 30)
	0.15			% typ	$R_L = 10 \text{ k}\Omega, 5 \text{ V rms}, f = 20 \text{ Hz to } 20 \text{ kHz}$
	960			MHz typ	$R_L = 50 \Omega, C_L = 1 \text{ pF}$ (see Figure 31)
	1.7			pF typ	$V_S = 0 \text{ V}, f = 1 \text{ MHz}$
	2.2			pF max	
	1.7			pF typ	$V_S = 0 \text{ V}, f = 1 \text{ MHz}$
	2.2			pF max	
	3			pF typ	$V_S = 0 \text{ V}, f = 1 \text{ MHz}$
$C_D$ (Off)	4			pF max	
$C_D, C_S$ (On)					
POWER REQUIREMENTS					$V_{DD} = +16.5 \text{ V}, V_{SS} = -16.5 \text{ V}$
$I_{DD}$	0.001		1.0	$\mu\text{A}$ typ	Digital inputs = 0 V or $V_{DD}$
	140		190	$\mu\text{A}$ max	Digital inputs = 0 V or $V_{DD}$
$I_{SS}$	0.001			$\mu\text{A}$ typ	Digital inputs = 5 V
			1.0	$\mu\text{A}$ max	Digital inputs = 5 V
$V_{DD}/V_{SS}$			$\pm 5/\pm 16.5$	V min/max	Digital inputs = 0 V, 5 V, or $V_{DD}$
					GND = 0 V

<sup>1</sup> Guaranteed by design, not subject to production test.

## SINGLE SUPPLY

$V_{DD} = 12 \text{ V} \pm 10\%$ ,  $V_{SS} = 0 \text{ V}$ , GND = 0 V, unless otherwise noted.

Table 2.

Parameter	Temperature			Unit	Test Conditions/Comments
	25°C	-40°C to +85°C	-40°C to +125°C		
ANALOG SWITCH					
Analog Signal Range			0 V to $V_{DD}$	V	
On Resistance, $R_{ON}$					
	300			$\Omega$ typ	$V_{DD} = 10.8 \text{ V}, V_{SS} = 0 \text{ V}, V_S = 0 \text{ V to } 10 \text{ V}, I_S = -1 \text{ mA}$ (see Figure 23)
	475	567	625	$\Omega$ max	
On Resistance Match Between Channels, $\Delta R_{ON}$					$V_S = 0 \text{ V to } 10 \text{ V}, I_S = -1 \text{ mA}$
	4.5			$\Omega$ typ	
	16	26	27	$\Omega$ max	
On Resistance Flatness, $R_{FLAT(ON)}$	60			$\Omega$ typ	$V_S = 3 \text{ V}/6 \text{ V}/9 \text{ V}, I_S = -1 \text{ mA}$
LEAKAGE CURRENTS					
Source Off Leakage, $I_S$ (Off)					$V_{DD} = 13.2 \text{ V}, V_{SS} = 0 \text{ V}$
	$\pm 0.002$			nA typ	$V_S = 1 \text{ V}/10 \text{ V}, V_D = 10 \text{ V}/1 \text{ V}$ (see Figure 24)
	$\pm 0.1$	$\pm 0.6$	$\pm 1$	nA max	
Drain Off Leakage, $I_D$ (Off)					$V_S = 1 \text{ V}/10 \text{ V}, V_D = 10 \text{ V}/1 \text{ V}$ (see Figure 24)
	$\pm 0.002$			nA typ	
	$\pm 0.1$	$\pm 0.6$	$\pm 1$	nA max	

# ADG1221/ADG1222/ADG1223

Parameter	Temperature			Unit	Test Conditions/Comments
	25°C	-40°C to +85°C	-40°C to +125°C		
Channel On Leakage, $I_D$ , $I_S$ (On)	$\pm 0.01$ $\pm 0.2$	$\pm 0.6$	$\pm 1$	nA typ nA max	$V_S = V_D = 1 \text{ V}$ or $10 \text{ V}$ (see Figure 25)
DIGITAL INPUTS					
Input High Voltage, $V_{INH}$			2.0	V min	
Input Low Voltage, $V_{INL}$			0.8	V max	
Input Current, $I_{INL}$ or $I_{INH}$	0.001			$\mu\text{A}$ typ $\mu\text{A}$ max	$V_{IN} = V_{INL}$ or $V_{INH}$
Digital Input Capacitance, $C_{IN}$	3		$\pm 0.1$	pF typ	
DYNAMIC CHARACTERISTICS <sup>1</sup>					
$t_{ON}$	190 250	300	345	ns typ ns max	$R_L = 300 \Omega$ , $C_L = 35 \text{ pF}$ , $V_S = 8 \text{ V}$ (see Figure 26)
$t_{OFF}$	120 150	190	225	ns typ ns max	$R_L = 300 \Omega$ , $C_L = 35 \text{ pF}$ , $V_S = 8 \text{ V}$ (see Figure 26)
Break-Before-Make Time Delay (ADG1223 Only), $t_{BBM}$	70		10	ns typ ns min	$R_L = 300 \Omega$ , $C_L = 35 \text{ pF}$ , $V_{S1} = V_{S2} = 8 \text{ V}$ (see Figure 27)
Charge Injection, $Q_{INJ}$	0.2			pC typ	$V_S = 6 \text{ V}$ , $R_S = 0 \Omega$ , $C_L = 1 \text{ nF}$ (see Figure 28)
Off Isolation	75			dB typ	$R_L = 50 \Omega$ , $C_L = 1 \text{ pF}$ , $f = 1 \text{ MHz}$ (see Figure 29)
Channel-to-Channel Crosstalk	90			dB typ	$R_L = 50 \Omega$ , $C_L = 1 \text{ pF}$ , $f = 1 \text{ MHz}$ (see Figure 30)
-3 dB Bandwidth $C_S$ (Off)	550			MHz typ	$R_L = 50 \Omega$ , $C_L = 1 \text{ pF}$ (see Figure 31) $V_S = 6 \text{ V}$ , $f = 1 \text{ MHz}$
$C_D$ (Off)	2.1 2.6			pF typ pF max	$V_S = 6 \text{ V}$ , $f = 1 \text{ MHz}$
$C_D$ , $C_S$ (On)	2.1 2.6			pF typ pF max	$V_S = 6 \text{ V}$ , $f = 1 \text{ MHz}$
	3.8 4.6			pF typ pF max	
POWER REQUIREMENTS					
$I_{DD}$	0.001		1.0	$\mu\text{A}$ typ $\mu\text{A}$ max	$V_{DD} = 13.2 \text{ V}$ Digital inputs = 0 V or $V_{DD}$
$V_{DD}$	140		190 5/16.5	$\mu\text{A}$ typ $\mu\text{A}$ max V min/max	Digital inputs = 0 V or $V_{DD}$ Digital inputs = 5 V Digital inputs = 5 V $V_{SS} = 0 \text{ V}$ , GND = 0 V

<sup>1</sup> Guaranteed by design, not subject to production test.

# ADG1221/ADG1222/ADG1223

## ABSOLUTE MAXIMUM RATINGS

T<sub>A</sub> = 25°C, unless otherwise noted.

Table 3.

Parameter	Rating
V <sub>DD</sub> to V <sub>SS</sub>	35 V
V <sub>DD</sub> to GND	-0.3 V to +25 V
V <sub>SS</sub> to GND	+0.3 V to -25 V
Analog Inputs <sup>1</sup>	V <sub>SS</sub> – 0.3 V to V <sub>DD</sub> + 0.3 V or 30 mA, whichever occurs first
Digital Inputs <sup>1</sup>	GND – 0.3 V to V <sub>DD</sub> + 0.3 V or 30 mA, whichever occurs first
Peak Current, S or D	100 mA (pulsed at 1 ms, 10% duty cycle max)
Continuous Current per Channel, S or D	30 mA
Operating Temperature Range	-40°C to +125°C
Storage Temperature Range	-65°C to +150°C
Junction Temperature	150°C
Reflow Soldering Peak Temperature, Pb free	260°C

<sup>1</sup> Overvoltages at IN, S, or D are clamped by internal diodes. Current must be limited to the maximum ratings given.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## THERMAL RESISTANCE

θ<sub>JA</sub> is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

Table 4. Thermal Resistance

Package Type	θ <sub>JA</sub>	θ <sub>Jc</sub>	Unit
10-Lead MSOP (4-Layer Board)	206	44	°C/W

## ESD CAUTION



### ESD (electrostatic discharge) sensitive device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

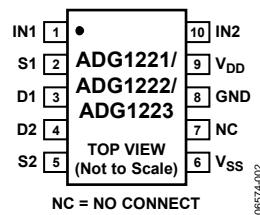


Figure 3. 10-Lead MSOP Pin Configuration

Table 5. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	IN1	Logic Control Input.
2	S1	Source Terminal. Can be an input or output.
3	D1	Drain Terminal. Can be an input or output.
4	D2	Drain Terminal. Can be an input or output.
5	S2	Source Terminal. Can be an input or output.
6	V <sub>ss</sub>	Most Negative Power Supply Potential.
7	NC	No Connect.
8	GND	Ground (0 V) Reference.
9	V <sub>dd</sub>	Most Positive Power Supply Potential.
10	IN2	Logic Control Input.

Table 6. ADG1221/ADG1222 Truth Table

ADG1221 INx	ADG1222 INx	Switch Condition
1	0	On
0	1	Off

Table 7. ADG1223 Truth Table

ADG1223 INx	Switch 1 Condition	Switch 2 Condition
0	Off	On
1	On	Off

# ADG1221/ADG1222/ADG1223

## TERMINOLOGY

**I<sub>DD</sub>**

The positive supply current.

**I<sub>SS</sub>**

The negative supply current.

**V<sub>D</sub> (V<sub>S</sub>)**

The analog voltage on Terminal D and Terminal S.

**R<sub>ON</sub>**

The ohmic resistance between Terminal D and Terminal S.

**R<sub>FLAT(ON)</sub>**

Flatness is defined as the difference between the maximum and minimum value of on resistance, as measured over the specified analog signal range.

**I<sub>S</sub> (Off)**

The source leakage current with the switch off.

**I<sub>D</sub> (Off)**

The drain leakage current with the switch off.

**I<sub>D</sub>, I<sub>S</sub> (On)**

The channel leakage current with the switch on.

**V<sub>INL</sub>**

The maximum input voltage for Logic 0.

**V<sub>INH</sub>**

The minimum input voltage for Logic 1.

**I<sub>INL</sub> (I<sub>INH</sub>)**

The input current of the digital input.

**C<sub>S</sub> (Off)**

The off switch source capacitance, measured with reference to ground.

**C<sub>D</sub> (Off)**

The off switch drain capacitance, measured with reference to ground.

**C<sub>D</sub>, C<sub>S</sub> (On)**

The on switch capacitance, measured with reference to ground.

**C<sub>IN</sub>**

The digital input capacitance.

**t<sub>ON</sub>**

The delay between applying the digital control input and the output switching on (see Figure 26).

**t<sub>OFF</sub>**

The delay between applying the digital control input and the output switching off (see Figure 26).

**t<sub>BBM</sub>**

Off time or on time measured between the 90% points of both switches, when switching from one address state to another (ADG1223 only).

**Q<sub>INJ</sub> (Charge Injection)**

A measure of the glitch impulse transferred from the digital input to the analog output during switching.

**Off Isolation**

A measure of unwanted signal coupling through an off switch.

**Crosstalk**

A measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance.

**-3 dB Bandwidth**

The frequency at which the output is attenuated by 3 dB.

**On Response**

The frequency response of the on switch.

**Insertion Loss**

The loss due to the on resistance of the switch.

**THD + N (Total Harmonic Noise Plus Distortion)**

The ratio of the harmonic amplitude plus noise of the signal to the fundamental.

**ACPSRR (AC Power Supply Rejection Ratio)**

Measures the ability of a part to avoid coupling noise and spurious signals that appear on the supply voltage pin to the output of the switch. The dc voltage on the device is modulated by a sine wave of 0.62 V p-p. The ratio of the amplitude of signal on the output to the amplitude of the modulation is the ACPSRR.

## TYPICAL PERFORMANCE CHARACTERISTICS

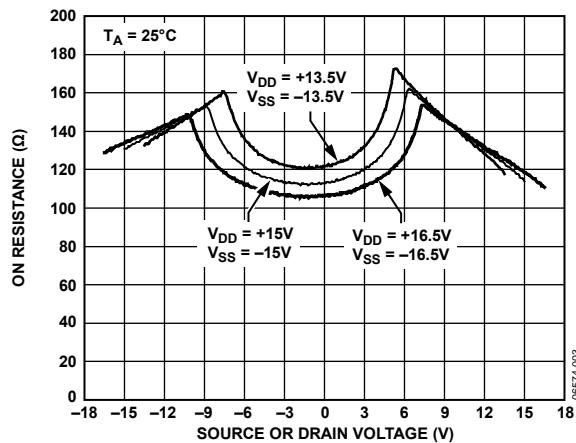
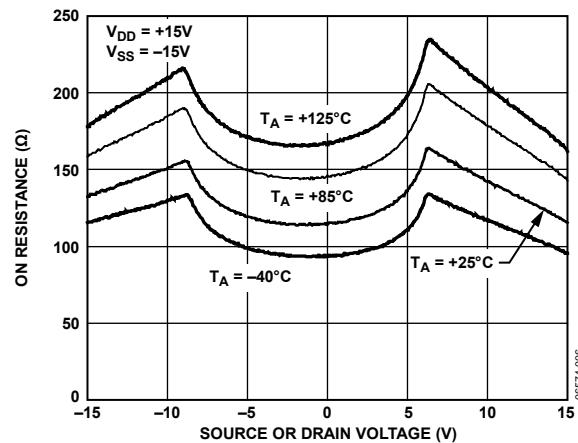
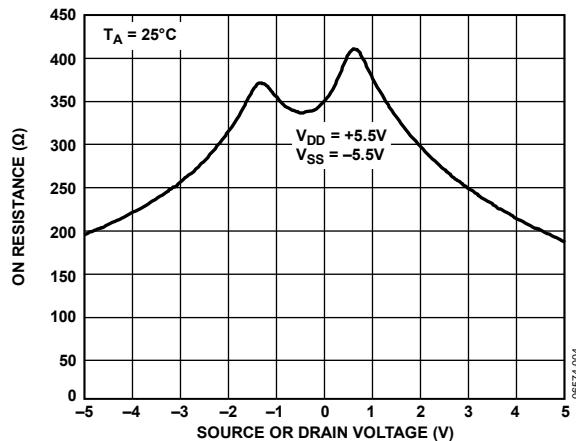
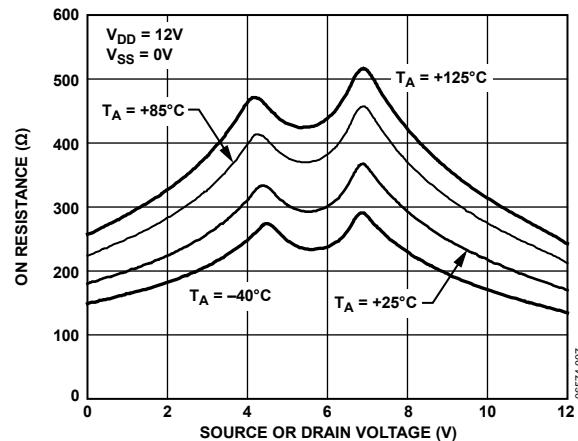
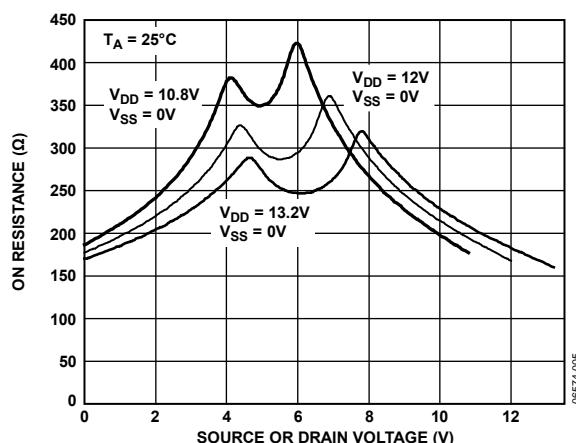
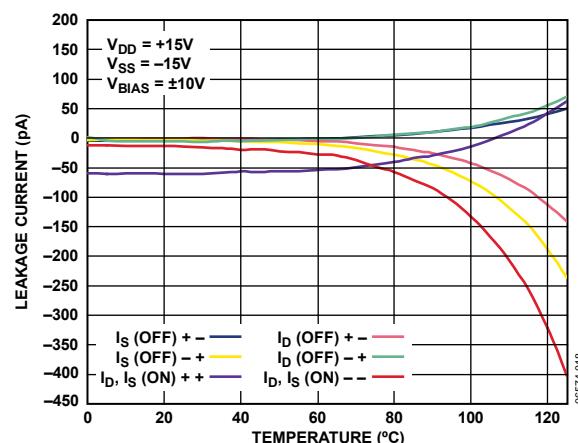
Figure 4. On Resistance as a Function of  $V_S$  ( $V_D$ ), Dual SupplyFigure 7. On Resistance as a Function of  $V_S$  ( $V_D$ ) for Different Temperatures, Dual SupplyFigure 5. On Resistance as a Function of  $V_S$  ( $V_D$ ), Dual SupplyFigure 8. On Resistance as a Function of  $V_S$  ( $V_D$ ) for Different Temperatures, Single SupplyFigure 6. On Resistance as a Function of  $V_S$  ( $V_D$ ), Single Supply

Figure 9. Leakage Current as a Function of Temperature, Dual Supply

# ADG1221/ADG1222/ADG1223

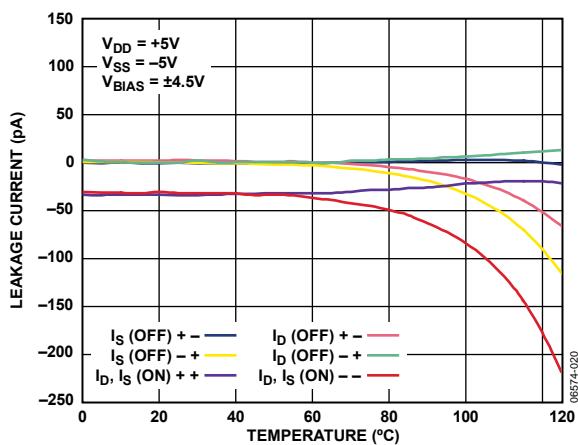


Figure 10. Leakage Current as a Function of Temperature, Dual Supply

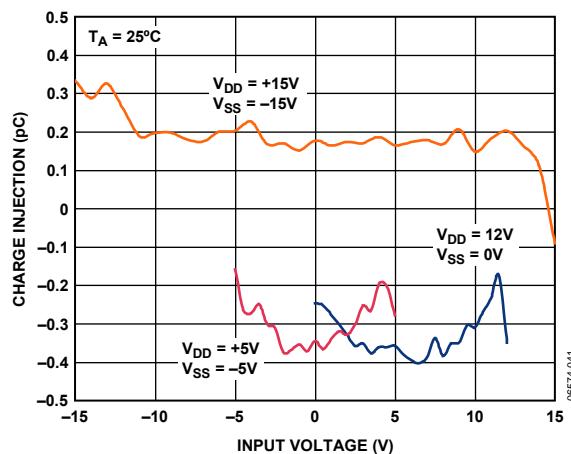


Figure 13. Charge Injection vs. Input Voltage

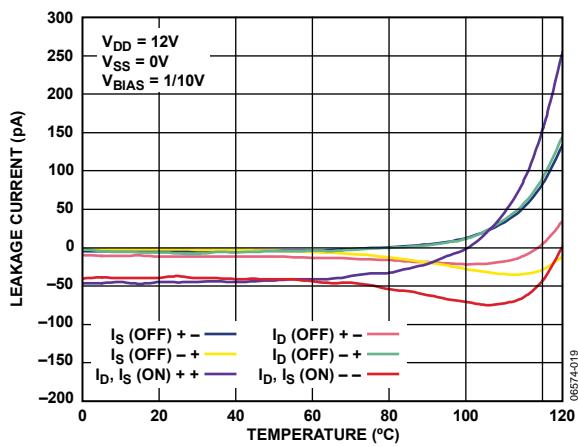


Figure 11. Leakage Current as a Function of Temperature, Single Supply

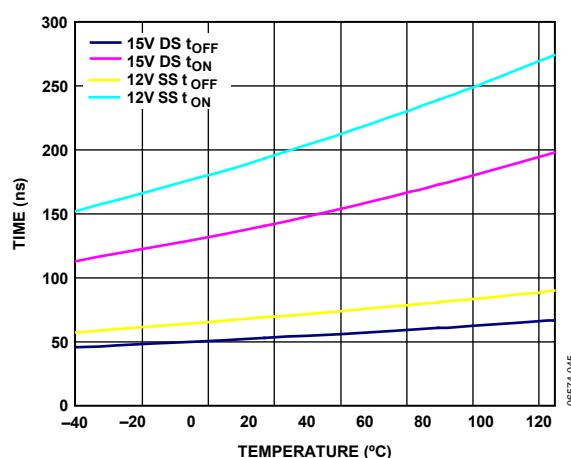


Figure 14.  $t_{ON}/t_{OFF}$  vs. Temperature

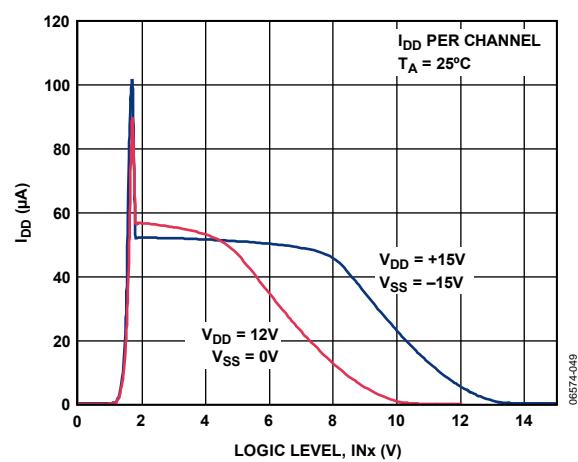


Figure 12.  $I_{DD}$  vs. Logic Level

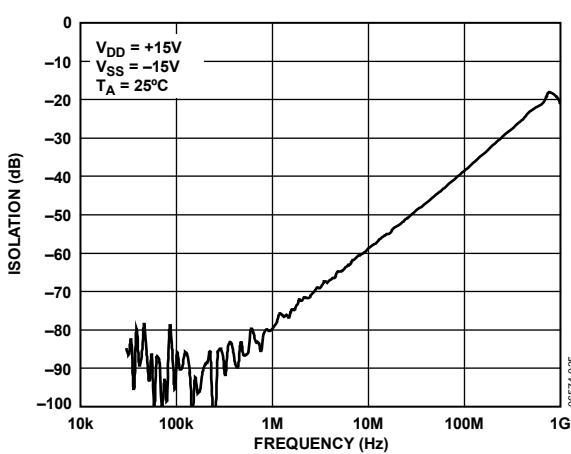


Figure 15. Off Isolation vs. Frequency

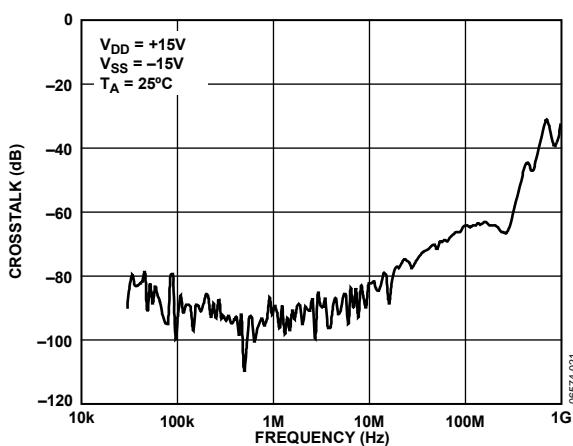


Figure 16. Crosstalk vs. Frequency

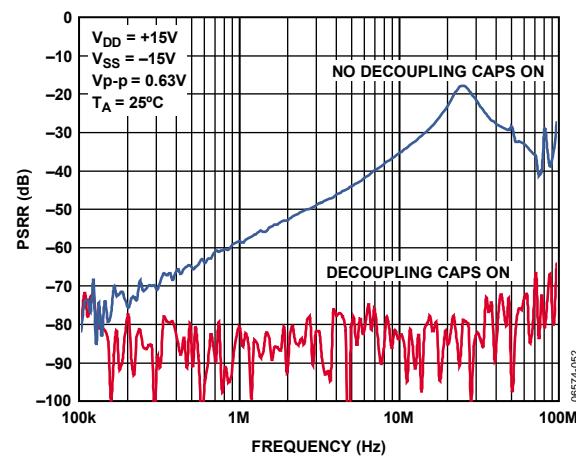


Figure 18. ACPSRR vs. Frequency

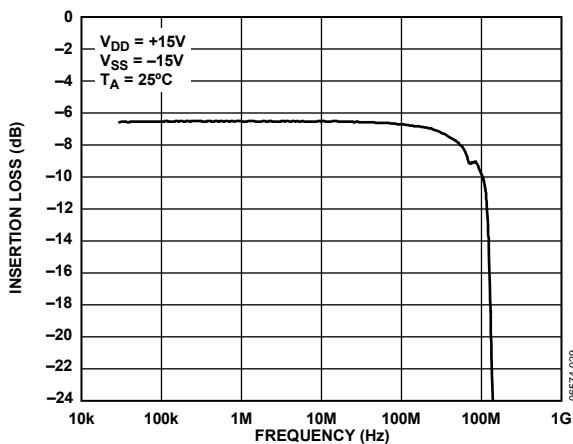


Figure 17. Insertion Loss vs. Frequency

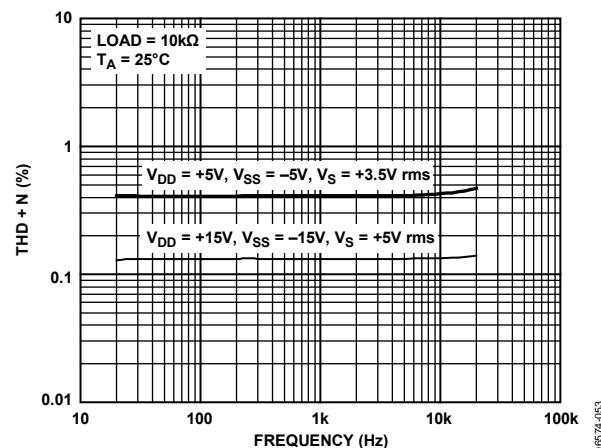
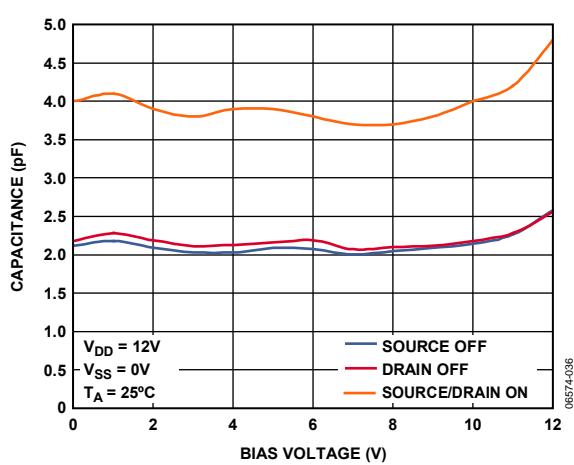
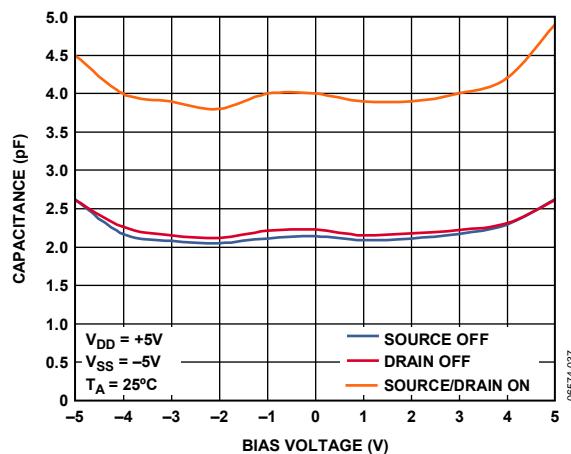
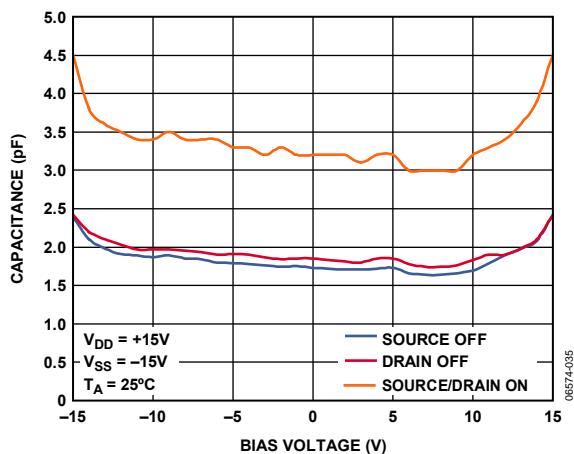
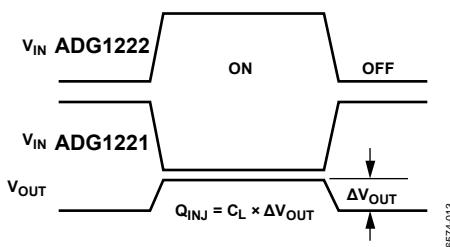
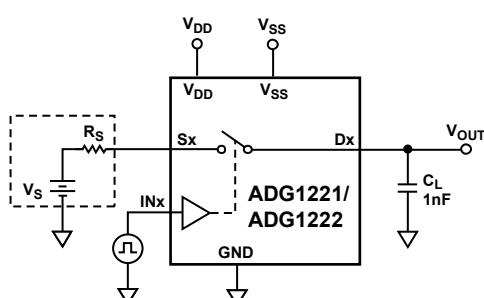
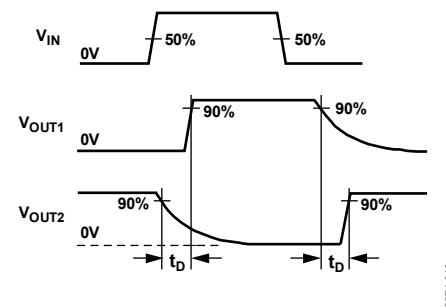
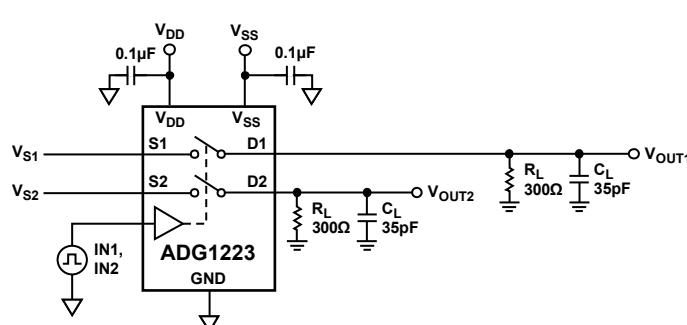
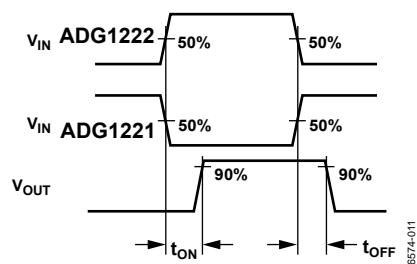
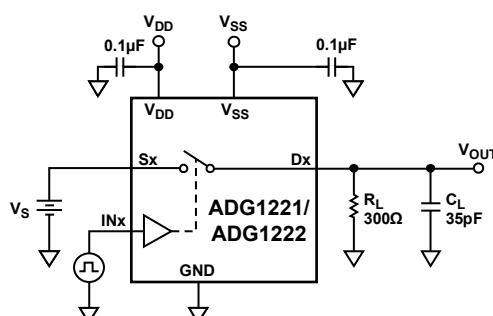
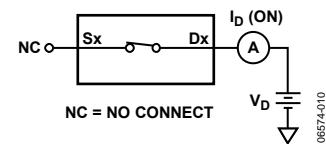
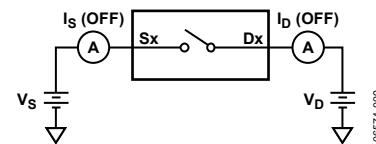
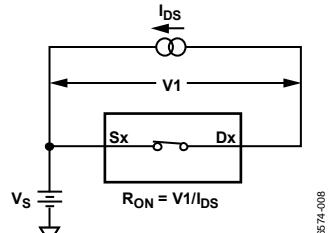


Figure 19. THD + N vs. Frequency

# ADG1221/ADG1222/ADG1223



## TEST CIRCUITS



# ADG1221/ADG1222/ADG1223

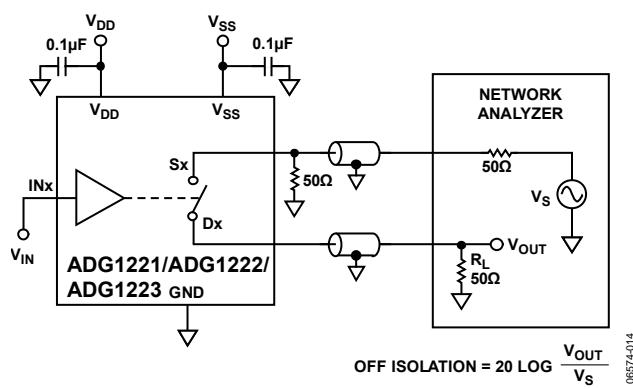


Figure 29. Test Circuit 7—Off Isolation

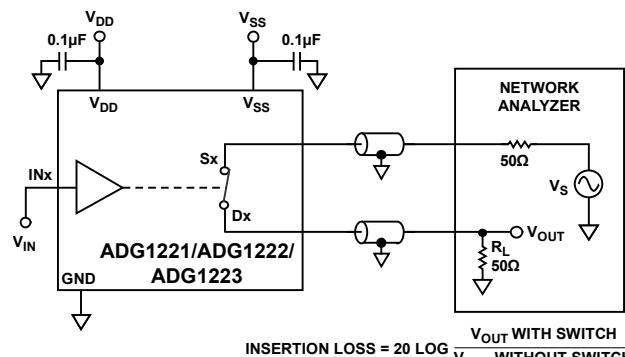


Figure 31. Test Circuit 9—Bandwidth

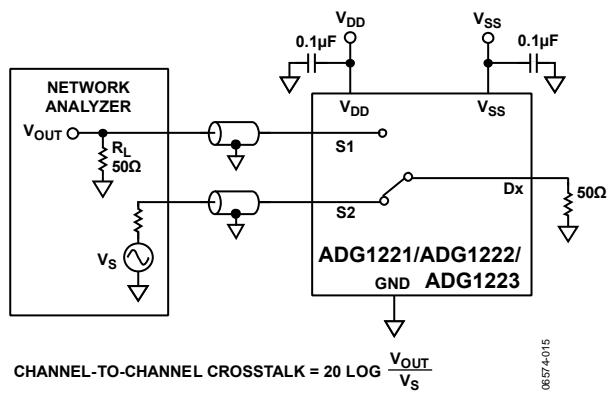


Figure 30. Test Circuit 8—Channel-to-Channel Crosstalk

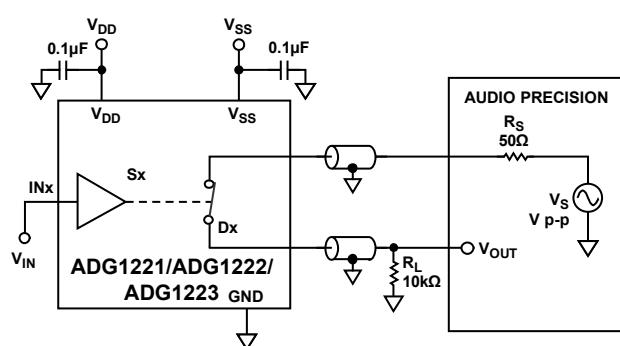
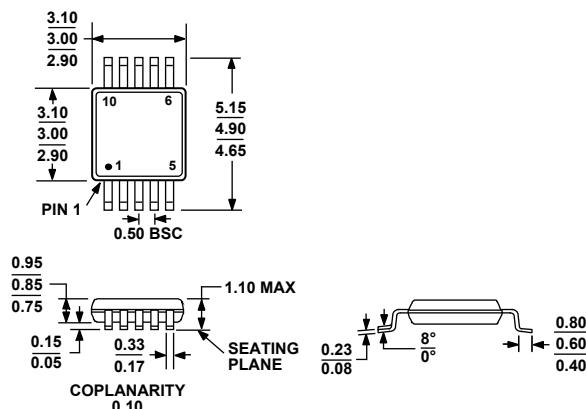


Figure 32. Test Circuit 10—Total Harmonic Distortion + Noise

# OUTLINE DIMENSIONS



**COMPLIANT TO JEDEC STANDARDS MO-187-BA**

*Figure 33. 10-Lead Mini Small Outline Package [MSOP]  
(RM-10)*

*Dimensions shown in millimeters*

## ORDERING GUIDE

Ordering Guide				
Model	Temperature Range	Package Description	Package Option	Branding
ADG1221BRMZ <sup>1</sup>	−40°C to +125°C	10-Lead Mini Small Outline Package (MSOP)	RM-10	S27
ADG1221BRMZ-REEL <sup>7</sup> <sup>1</sup>	−40°C to +125°C	10-Lead Mini Small Outline Package (MSOP)	RM-10	S27
ADG1222BRMZ <sup>1</sup>	−40°C to +125°C	10-Lead Mini Small Outline Package (MSOP)	RM-10	S28
ADG1222BRMZ-REEL <sup>7</sup> <sup>1</sup>	−40°C to +125°C	10-Lead Mini Small Outline Package (MSOP)	RM-10	S28
ADG1223BRMZ <sup>1</sup>	−40°C to +125°C	10-Lead Mini Small Outline Package (MSOP)	RM-10	S2J
ADG1223BRMZ-REEL <sup>7</sup> <sup>1</sup>	−40°C to +125°C	10-Lead Mini Small Outline Package (MSOP)	RM-10	S2J

<sup>1</sup> Z = Pb-free part.

# **ADG1221/ADG1222/ADG1223**

## **NOTES**

©2007–2009 Analog Devices, Inc. All rights reserved. Trademarks and registered trademarks are the property of their respective owners.  
D06574-0-3/09(A)



[www.analog.com](http://www.analog.com)